



DATA SHEET SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS Automotive grade Array

NPO/X7R 16 V TO 50 V sizes 0508 (4 x 0402) / 0612 (4 x 0603) RoHS compliant & Halogen Free



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Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

<u>SCOPE</u>

This specification describes Automotive grade NP0/X7R series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

- Professional electronics
- High density consumer electronics

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- 0508 (4x0402) / 0612 (4x0603) capacitors (of the same capacitance value) per array
- Less than 50% board space of an equivalent discrete component
- Increased throughout, by time saved in mounting
- RoHS compliant & Halogen free
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

AC <u>XXXX</u> <u>X</u> <u>X</u> <u>XXX</u> <u>X</u> B <u>X</u> <u>XXX</u> (1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0508 (1220) 0612 (1632)

(2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$
- $M = \pm 20\%$

(3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch

(4) TC MATERIAL

NPO

X7R

(5) RATED VOLTAGE

 $7 = 16 \vee$ $8 = 25 \vee$ $9 = 50 \vee$

(6) PROCESS

N = NP0B = class 2 material, X7R

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $|2| = |2 \times |0| = |20 \text{ pF}$

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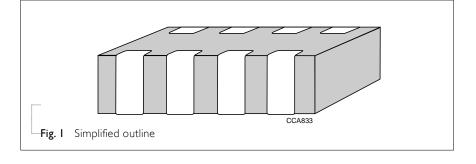
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CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. An outline of the structure is shown in Fig. I.



OUTLINES

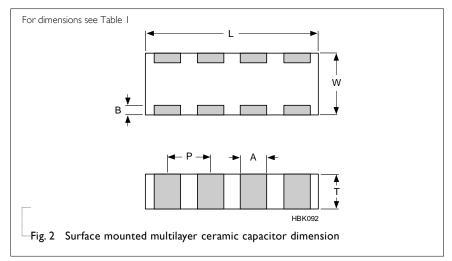


 Table I
 For outlines see fig. 2

ТҮРЕ	0508 (4 X 0402)	0612 (4 X 0603)
L (mm)	2.0 ±0.15	3.2 ±0.15
W (mm)	1.25 ±0.15	1.60 ±0.15
T _{min.} (mm)	*	*
T _{max.} (mm)	*	*
A (mm)	0.28 ±0.10	0.4 ±0.10
B (mm)	0.2 ±0.10	0.3 ±0.20
P (mm)	0.5 ±0.10	0.8 ±0.10

NOTE

* Refer to Table 2 ~Table 3

CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 2 Temperature characteristic material from NP0

CAPACITANCE	0508 (4 × 0402)	0612 (4 × 0603)
	50 V	50 V
I0 pF	0.6±0.1	0.8±0.1
15 pF	0.6±0.1	0.8±0.1
18 pF	0.6±0.1	0.8±0.1
22 pF	0.6±0.1	0.8±0.1
33 pF	0.6±0.1	0.8±0.1
39 pF	0.6±0.1	0.8±0.1
47 pF	0.6±0.1	0.8±0.1
56 pF	0.6±0.1	0.8±0.1
68 pF	0.6±0.1	0.8±0.1
82 pF	0.6±0.1	0.8±0.1
100 pF	0.6±0.1	0.8±0.1
120 pF		0.8±0.1
150 pF		0.8±0.1
180 pF		0.8±0.1
220 pF		0.8±0.1
270 pF		0.8±0.1
330 pF		0.8±0.1
390 pF		0.8±0.1
470 pF		0.8±0.1
560 pF		
680 pF		
820 pF		
I.0 nF		

ΝΟΤΕ

Values in shaded cells indicate thickness class in mm



CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 3 Temperature characteristic material from X7R

CAPACITANCE	0508 (4 × 0402)		(0612 (4 × 0603)		
	16 V	25 V	50 V	16 V	25 V	50 V
I.0 nF	0.6±0.1	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1	0.8±0.1
I.5 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
2.2 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
3.3 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
4.7 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
6.8 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
10 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
22 nF	0.6±0.1					
47 nF	0.6±0.1			0.8±0.1	0.8±0.1	
100 nF	0.6±0.1					

ΝΟΤΕ

Values in shaded cells indicate thickness class in mm

THICKNESS CLASSES AND PACKING QUANTITY

Table 4						
	THICKNESS	Ø180	MM / 13 INCH			
SIZE CODE		TAPE WIDTH QUANTITY PER REEL	Paper	Blister	Paper	Blister
0508	0.6 ±0.1 mm	8 mm	4,000		20,000	
0612	0.8 ±0.1 mm	8 mm	4,000		15,000	

ELECTRICAL CHARACTERISTICS

NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15° C to 35° C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 5		
DESCRIPTION		VALUE
Capacitance range		10 pF to 100 nF
Capacitance tolerance		
NP0	$C \ge 10 \text{ pF}$	±5%
X7R		±10%, ±20%
Dissipation factor (D.F.)		
NP0	C < 30 pF	≤ I / (400 + 20C)
	C ≥ 30 pF	≤ 0.1%

X7R	0508 (Array)	0612 (Array)	
16V	InF to 10nF	220pF to 47nF	≤ 3.5%
	I5nF to I00nF		≤ 5%
25∨	InF to IOnF	220pF to 47nF	≤ 2.5%
50V	InF	220pF to 10nF	≤ 2.5%
Insulation resista	nce after I minute at U _r (DC)	IR ≥ 10G Ω or I.R × C ≥ 500 seconds	nds whichever is less

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C ٠
- Endurance: 95 to 120 seconds
- Cycles: 3 times •

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Capacitance	IEC 60384- 21/22	4.5.1	Class I: At 20 °C, 24 hours after annealing $f = 1 \text{ MHz}$ for $C \le 1 \text{ nF}$, measuring at voltage 1 V_{rms} at 20 °C $f = 1 \text{ KHz}$ for $C > 1 \text{ nF}$, measuring at voltage 1 V_{rms} at 20 °C Class 2: At 20 °C, 24 hours after annealing $f = 1 \text{ KHz}$, measuring at voltage 1 V_{rms} at 20 °C	Within specified tolerance
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20 °C, 24 hours after annealing $f = 1$ MHz for $C \le InF$, measuring at voltage 1 V _{rms} at 20 °C f = 1 KHz for $C > InF$, measuring at voltage 1 V _{rms} at 20 °C Class 2: At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	In accordance with specification
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U_r (DC) for 1 minute	In accordance with specification
High Temperature Exposure	AEC-Q200	3	Unpowered ; 1000hours @ T=150 °C Measurement at 24±2 hours after test conclusion.	No visual damage $\Delta C/C$: Class1: NP0: within ±0.5% or 0.5 pF whichever is greater Class2: X7R: ±10% D.F.: within initial specified value IR: within initial specified value

Table 6 Test procedures and requirements

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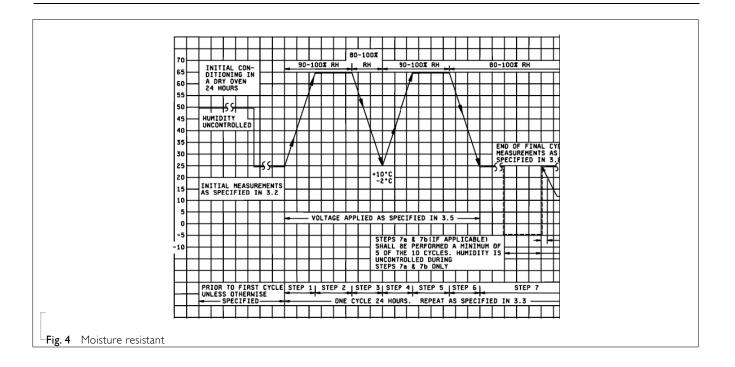
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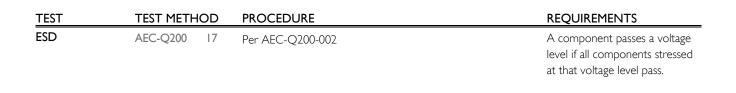
TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for	No visual damage
			24 \pm 1 hours at room temperature	$\Delta C/C$
			1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours	Class I: NP0: Within ±1% or 0.5pF, whichever is greater. Class2: X7R: ±10%
				D.F. meet initial specified value
				IR meet initial specified value
Destructive Physical Analysis	AEC-Q200	5	Note: Only applies to SMD ceramics. Electrical test not required.	
Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 \pm 2 hours after test condition.	No visual damage
				Δ C/C NP0: Within ±3% or 3 pF, whichever is greater X7R: ±15%
				D.F.
				Within initial specified value
				IR
				NP0: ≥ 10,000 MΩ
				X7R: Meet initial specified value

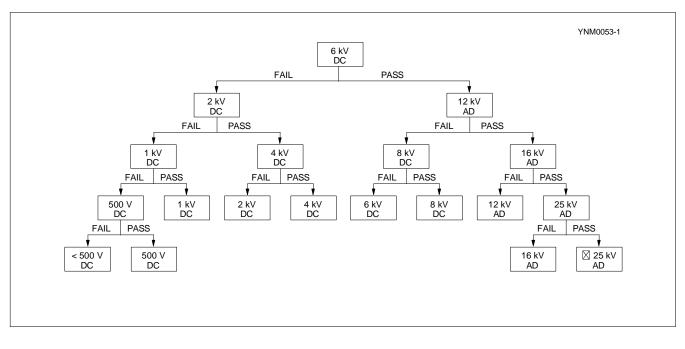


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TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS						
Biased Humidity	AEC-Q200	7	 Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 	No visual damage after recovery						
			 Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U_r for 1,000 hours. 	Δ C/C NPO: Within ± 2% or 1 pF, whichever is greater X7R: ± 15% D.F.						
			 4. Recovery: Class I: 6 to 24 hours Class 2: 24 ±2 hours 5. Final measure: Cap, D.F., I.R. 	NPO: $\leq 2 \times$ specified value. X7R/X7S: (1) $\leq 16V: \leq 7\%$ or specified value whichever is greater (2) $\geq 25V: \leq 5\%$ or specified						
				value whichever is greater I.R. The insulation resistance shall greater than 10% of initial spec.						
Operational Life	e AEC-Q200	8	1. Preconditioning, class 2 only: $150 \pm 0/10^{\circ}$ C /1 hours then keep for	No visual damage						
		 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Endurance test: 	24 ± I hour at room temp 2. Initial measure:	Δ C/C NP0: Within ±2% or 1 pF, whichever is greater X7R: ±15%						
			Temperature: X7R: 125 °C Specified stress voltage applied for 1,000 hours: Applied 2.0 × U _r s 4. Recovery time: 24 ±2 hours	D.F. NP0: $\leq 2 \times$ specified value. X7R: $\leq 16V$: $\leq 7\%$ or specified						
									5. Final measure: C, D, IR Note: If the capacitance value is less than the minimum value	value whichever is greater ≥ 25V: ≤ 5% or specified value whichever is greater
			permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.	IR NP0: ≥ 4,000 M Ω or IR × C _r ≥ 40s whichever is less X7R: ≥ 1,000 M Ω or IR× C _r ≥ 50s whichever is less						
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification						
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification						

TEST	TEST METH	IOD	PROCEDURE	REQUIREMENTS
Mechanical Shock	AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Waveform: Half-sin	ΔC/C NP0: Within ±0.5% or 0.5 pF, whichever is greater X7R: ±10% D.F. Within initial specified value IR Within initial specified value
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations.	ΔC/C NP0: Within ±0.5% or 0.5 pF, whichever is greater X7R: ±10%
				D.F: meet initial specified value IR meet initial specified value
Resistance to Soldering Heat	AEC-Q200	15	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Preheating: 120 °C to 150 °C for 1 minute Solder bath temperature: 260 ±5 °C Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned ΔC/C Class I: NP0: Within ±1% or 0.5 pF, whichever is greater. Class2: X7R: ±10%
				D.F. within initial specified value IR within initial specified value
Thermal Shock	AEC-Q200	16	 Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room . temp Initial measure: Spec: refer to initial spec C, D, IR Rapid change of temperature test: NP0/X7R: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature. Recovery time: Class1: 6 to 24 hours Class2: 24 ±2 hours Final measure: C, D, IR 	No visual damage ΔC/C NP0: Within ±1% or 1 pF, whichever is greater X7R: ±15% D.F: meet initial specified value IR meet initial specified value





Solderability	AEC-Q200	18	I. Preheat at 155°C for 4 hours. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.	The solder should cover over 95% of the critical area of each termination.
			 Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C. 	
			 Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of Ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 120±5 seconds at 260±5°C. 	

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Electrical Characterization	AEC-Q200		summary to show Min, Max, Mean and Standard deviation at	ΔC/C Class I: NP0: ±30 ppm/°C Class2:
			Class I: NP0: -55 °C to +125 °C Normal temperature: 20 °C Class 2: X7R: -55 °C to +125 °C Normal temperature: 20 °C	X7R: ±15%
Board Flex	AEC-Q200	21	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick Part should be mounted using the following soldering reflow profile. Conditions: Class 1: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm Class2: Bending 2 mm at a rate of 1 mm/s, radius jig 340 mm	No visible damage ΔC/C Class I : NP0: Within ±1% or 0.5 pF, whichever is greater Class2: X7R: ±10%
Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before and after the test, the device shall comply with all electrical requirements stated in this specification.
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	0508: 20N 0612: 15N
Voltage Proof			 Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: applied 2.5 Ur Charge/Discharge current is less than 50 mA 	No breakdown or flashover

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Jul. 09, 202 I	-	- New Datasheet

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